

Title (en)
DEVELOPER-FREE THERMOSENSITIVE RECORDING MATERIAL

Title (de)
ENTWICKLERFREIES WÄRMEEMPFLINDLICHES AUFZEICHNUNGSMATERIAL

Title (fr)
MATIÈRE D'ENREGISTREMENT THERMOSENSIBLE SANS GÉNÉRATEUR

Publication
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Application
EP 20191808 A 20200819

Priority
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Abstract (en)
[origin: CA3128553A1] The present invention relates to a heat-sensitive recording material comprising or consisting of a) a carrier substrate (preferably paper substrate) and b) a fusible layer disposed on one side of the carrier substrate or paper substrate, wherein the fusible layer comprises or consists of i) an amide wax having a melting point in the range from 60 C to 180 C, ii) an inorganic pigment and iii) a polymeric binder. The present invention additionally relates to a coating composition for producing a corresponding fusible layer, to a process for producing a heat-sensitive recording material and to the use of a heat-sensitive recording material.

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Citation (opposition)
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